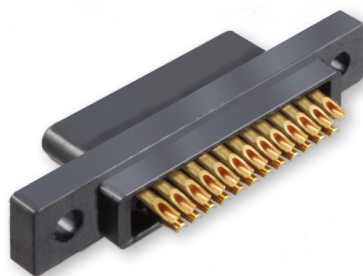


MWDL Low Profile Plastic Shell Micro-D Solder Cup Termination



Micro-D Double
and Triple Row



These .050" pitch all-plastic solder cup Micro-D connectors accept #26 to #30 gage wire with standard contacts and up to size #24 wire with "large bore" contacts. Contacts are factory-installed and potted with epoxy. Pin contacts are gold-plated high performance TwistPin type and are recessed into insulator to prevent damage. Socket contacts are gold plated, machined copper alloy. Glass-filled high temperature thermoplastic insulators withstand soldering heat. Meets performance requirements of MIL-DTL-83513, Class P. Available with 9 to 51 contacts. 3 A., 600 Vac, -55°C to +150°C.

How To Order Solder Cup Connector

Sample Part Number		MWDL	-25	SS	B
Series	MWDL - Low Profile Plastic Shell Micro-D				
Contact Layout	9, 15, 21, 25, 31, 37, 51 (See Table II)				
Contact Type	Size #26 Solder Cup Contacts (Standard) Size #24 Solder Cup Contacts PS - Pin NS - Pin SS - Socket TS - Socket				
Mounting Hardware	B, P, M, M1, S, S1 (See Table I)				

E

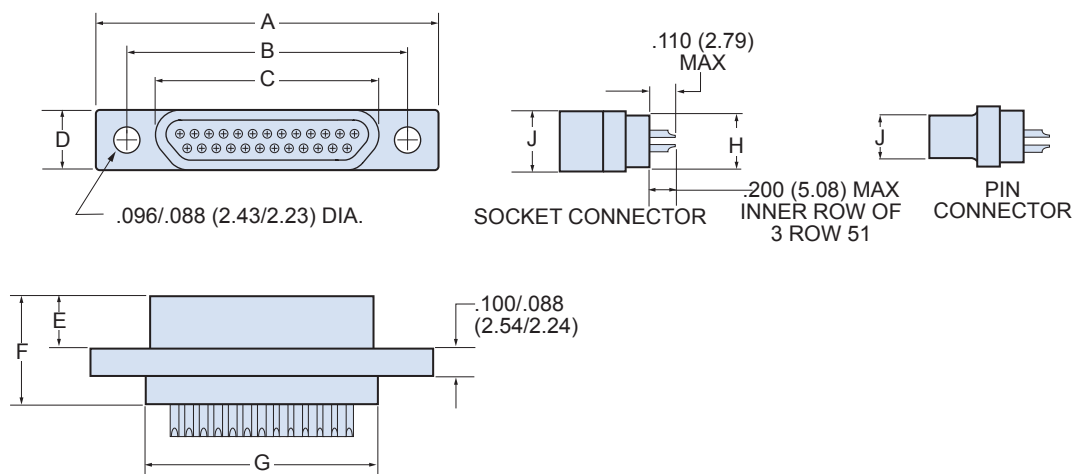
Table I: Mounting Hardware

B	P	M	M1	S	S1
Thru-Hole	Jackpost #2-56	Hex Head Jackscrew #2-56	Hex Head Jackscrew, Extended #2-56	Slot Head Jackscrew #2-56	Slot Head Jackscrew, Extended #2-56



MWDL Low Profile Plastic Shell Micro-D Solder Cup Termination

Table II: Dimensions



Layout	A Max.		B		C Max.		D Max.		E Max.		F Max.		G Max.		H Max.		J Max.	
	In.	mm.	In. $\pm .003$	mm. ± 0.08	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.
9P	.788	20.02	.565	14.35	.292	7.42	.218	5.54	.202	5.13	.395	10.03	.408	10.36	.173	4.39	.134	3.40
9S	.788	20.02	.565	14.35	.380	9.65	.218	5.54	.185	4.70	.375	9.53	.408	10.36	.173	4.39	.218	5.54
15P	.938	23.83	.715	18.16	.442	11.23	.218	5.54	.202	5.13	.395	10.03	.558	14.17	.173	4.39	.134	3.40
15S	.938	23.83	.715	18.16	.530	13.46	.218	5.54	.185	4.70	.375	9.53	.558	14.17	.173	4.39	.218	5.64
21P	1.088	27.64	.865	21.97	.592	15.04	.218	5.54	.202	5.13	.395	10.03	.708	17.98	.173	4.39	.134	3.40
21S	1.088	27.64	.865	21.97	.680	17.27	.218	5.54	.185	4.70	.375	9.53	.708	17.98	.173	4.39	.218	5.64
25P	1.188	30.18	.965	24.51	.692	17.58	.218	5.54	.202	5.13	.395	10.03	.808	20.52	.173	4.39	.134	3.40
25S	1.188	30.18	.965	24.51	.780	19.81	.218	5.54	.185	4.70	.375	9.53	.808	20.52	.173	4.39	.218	5.64
31P	1.338	33.99	1.115	28.32	.842	21.39	.218	5.54	.202	5.13	.395	10.03	.958	24.33	.173	4.39	.134	3.40
31S	1.338	33.99	1.115	28.32	.930	23.62	.218	5.54	.185	4.70	.375	9.53	.958	24.33	.173	4.39	.218	5.64
37P	1.488	37.80	1.265	32.13	.992	25.20	.218	5.54	.202	5.13	.395	10.03	1.108	28.14	.173	4.39	.134	3.40
37S	1.488	37.80	1.265	32.13	1.080	27.43	.218	5.54	.185	4.70	.375	9.53	1.108	28.14	.173	4.39	.218	5.64
51P	1.438	36.53	1.215	30.86	.942	23.93	.260	6.60	.202	5.13	.395	10.03	1.058	26.87	.220	5.59	.177	4.50
51S	1.438	36.53	1.215	30.86	1.030	26.16	.260	6.60	.185	4.70	.375	9.53	1.058	26.87	.220	5.59	.260	6.60

Performance Specifications

Current Rating	3 AMP
DWV	600 VAC Sea level
Insulation Resistance	5000 Megohms Minimum
Contact Resistance	8 Milliohms Maximum
Operating Temperature	-55° C. to +150° C.
Shock, Vibration	50 g., 20g.
Mating Force	(10 Ounces) X (# of Contacts)

Materials and Finishes

Insulator	Liquid Crystal Polymer (LCP)/ Polyphenylene Sulfide(PPS)
Pin Contact	Beryllium Copper, Gold over Nickel Plating
Socket Contact	Copper Alloy, Gold Over Nickel Plating
Hardware	300 Series Stainless Steel
Encapsulant	Epoxy